

# MX553ABD212M500

#### Ultra-Low Jitter 212.5MHz HCSL XO

#### **ClockWorks® FUSION**

### **General Description**

The MX553ABD212M500 is an ultra-low phase jitter XO with HCSL output optimized for high line rate applications.

#### Applications

• Fibre Channel 10G/12G SERDES

#### Absolute Maximum Ratings<sup>1</sup>

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T <sub>S</sub> ) ESD Machine Model	65°C to +125°C
ESD Machine Model	200V
ESD Rating (HBM)	2kV

#### **Electrical Characteristics**

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current				95	mA
F0	Center Frequency			212.5		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		134 80		fsRMS
Tstart	Start-Up Time				10	ms
TR/TF	Rise/Fall time	20%-80%	150	300	450	ps
	Duty Cycle		48	50	52	%
VOH	Output High Voltage	HCSL output levels	660	700	850	mV
VOL	Output Low Voltage	HCSL output levels	-150	0	27	mV
VOVS	Max Output Including Overshoot				VOH + 0.3	V
VUDS	Min Output Including Undershoot		VOL - 0.3			V
VRB	Ringback Voltage		0.2			V
VOX	Absolute Crossing Point		250	350	550	mV
Vswing	Peak to Peak Output Voltage Swing		640	700	950	mV

Notes:

1. Exceeding the absolute maximum ratings may damage the device.

2. The device is not guaranteed to function outside its operating ratings.

3. Guaranteed after thermal equilibrium.

4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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Revision 1.0 tcghelp@microchip.com

## **Features**

- 212.5MHz HCSL
- Typical phase noise:
  - 80fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- $-40^{\circ}$ C to  $+85^{\circ}$ C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

## **Operating Ratings<sup>2</sup>**

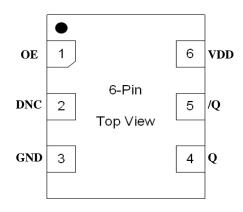
to +3.63V
to +85°C
58°C/W

# **Ordering Information**

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX553ABD212M500	MX553A	BD2125	Tube	6-Pin 5mm x 3.2mm LGA
MX553ABD212M500-TR	MX553A	BD2125	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

## **Pin Configuration**



# **Pin Description**

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ohms Pull-Up (Internal)
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	HCSL	Clock Output Frequency = 212.5MHz
6	VDD	PWR		Power Supply

## **Environmental Specifications**

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition C
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s
MSL Level	Crystal - MSL-1, Package MSL-3
Solvent Resistance	MIL-STD-202, Method 215

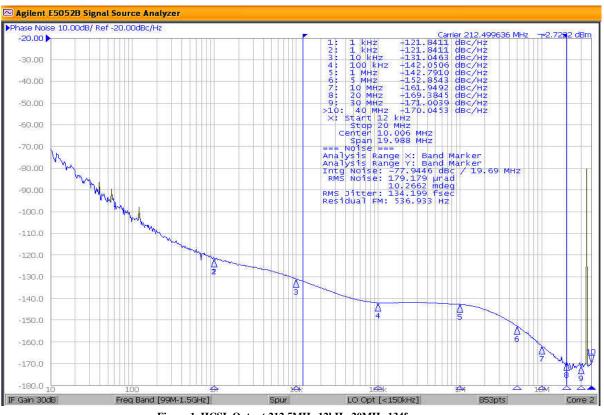
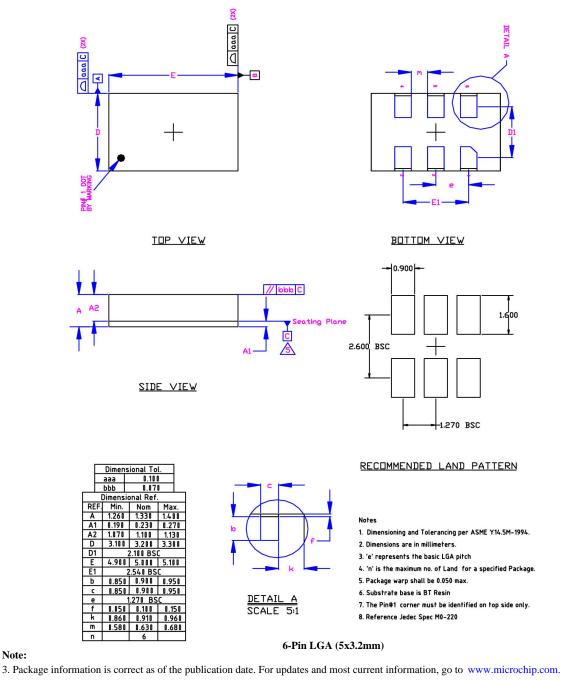


Figure 1. HCSL Output 212.5MHz 12kHz-20MHz 134fs

#### Package Information and Recommended Land Pattern for 6-Pin LGA<sup>3</sup>



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